# 2SA1806J

### Silicon PNP epitaxial planar type

For high speed switching

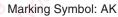
#### Features

- High speed switching
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- SS-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

1: Base 2: Emitter 3: Collector EIAJ: SC-89 SSMini3-F1 Package

### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-15	v	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-15	V	
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-4	V	
Collector current	I <sub>C</sub>	-50	mA	
Peak collector current	I <sub>CP</sub>	-100	mA	
Collector power dissipation	P <sub>C</sub>	125	mW	
Junction temperature	Tj	125	°C	
Storage temperature	T <sub>stg</sub>	-55 to +125	°C	



#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = -8 V, I_E = 0$	X0~ _	S	- 0.1	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{CE} = -3 V, I_C = 0$	s S	<sup>o</sup>	- 0.1	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = -1 V, I_C = -10 mA$	50		150	
	h <sub>FE2</sub>	$V_{CE} = -1 V, I_C = -1 mA$	30			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$		- 0.1	- 0.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$	800	1 500		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = -5 V, I_E = 0, f = 1 MHz$		1		pF
Turn-on time	t <sub>on</sub>	Refer to the switching time		12		ns
Turn-off time	t <sub>off</sub>	measurement circuit		20		ns
Storage time	t <sub>stg</sub>			19		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

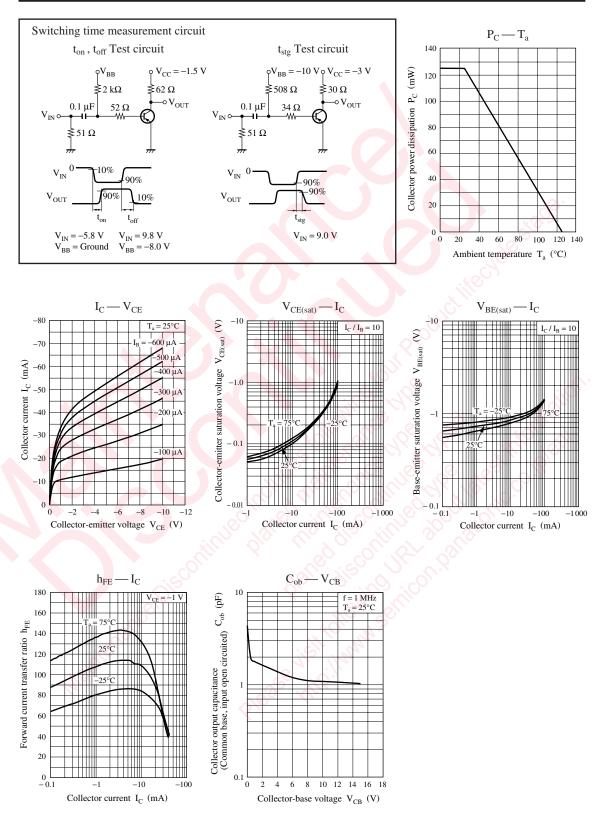
2. \*: Rank classification

Rank	Q	R		
h <sub>FE1</sub>	50 to 120	90 to 150		

Ranking is not given for any product.

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## **Panasonic**



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